

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Switching Diode

DA3J101J0L

Panasonic

DA3J101J0L

Silicon epitaxial planar type

For high speed switching circuits DA3X101J in SMini3 type package

Features

- Small reverse current IR
- Short reverse recovery time trr
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: 11

■ Basic Part Number : 2 elements anode-common type

■ Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

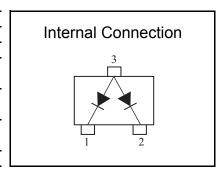
			Unit: mm	
2. 0				
0.3			0.13	
3		İ		
	2	2.1		
(0. 65)(0. 6	55)		0.9	
1. Cathoo	de1			
2. Cathode2				
3. Anode	1,2			
Panasonic	SMini3-F2-B			
JEITA	SC-85			

Panasonic	SMini3-F2-B
JEITA	SC-85
Code	_

■ Absolute Maximum Ratings Ta = 25 °C

Parameter		Symbol	Rating	Unit	
Reverse voltage		VR	80	V	
Maximum peak reverse voltage		VRM	80	V	
Forward current	Single	IF	100	mA	
	Double	11	150		
Peak forward current	Single	IFM	225	mA	
T ear forward current	Double	11 171	340		
Non-repetitive peak	Single	IFSM	500	mA	
forward surge current *1	Double	IFSIVI	750		
Junction temperature		Tj	150	°C	
Operating ambient temperature		Topr	-40 to +85	°C	
Storage temperature		Tstg	-55 to +150	°C	

Note) *1: t = 1 s



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Established: 2012-08-28 : 2013-06-04 Revised

Revision. 4

Switching Diode

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■ Electrical Characteristics Ta = 25 °C ± 3 °C

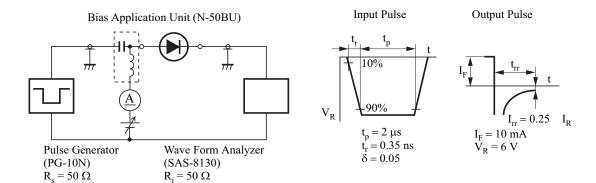
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 100 mA			1.2	V
Reverse voltage	VR	IR = 100 μA	80			V
Reverse current	IR	VR = 80 V			100	nA
Terminal capacitance	Ct	VR = 0 V, f = 1 MHz			2	pF
Reverse recovery time *1	trr	IF = 10 mA, VR = 6 V Irr = 0.25 x IR			3	ns

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
 - 2. Absolute frequency of input and output is 100 MHz.
 - 3. *1: trr test circuit

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Revised

: 2013-06-04



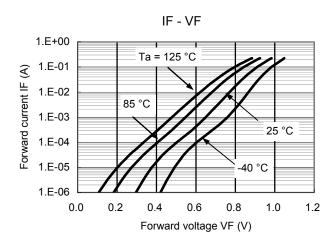
Panasonic

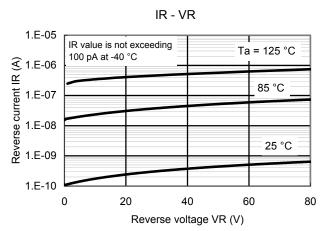
Revision. 4

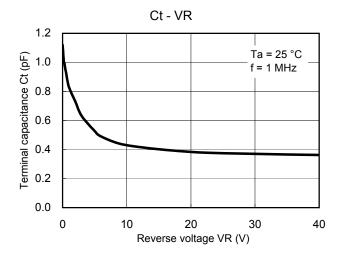
Switching Diode

DA3J101J0L

Technical Data (reference)







Established: 2012-08-28 Revised: 2013-06-04

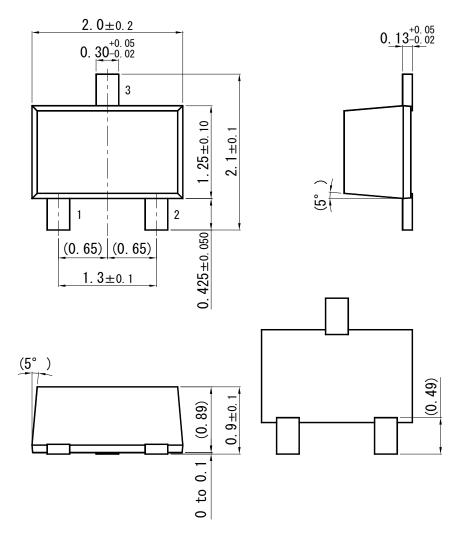
Switching Diode

DA3J101J0L

SMini3-F2-B

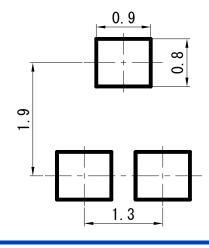
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Unit: mm



■ Land Pattern (Reference) (Unit: mm)

Established: 2012-08-28 Revised: 2013-06-04



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